

June 2010

FPF2193 / FPF214 / FPF2195 Full-Function Load Switch with Adjustable Current Limit

Features

- <1.8 to 5.5V Input Voltage Range</p>
- Controlled Turn-On
- 0.1 to 1.5A Adjustable Current Limit
- Under-Voltage Lockout
- Thermal Shutdown
- <2µA Shutdown Current</p>
- Auto Restart
- Fast Current Limit Response Time
- 5µs to Moderate Over Currents
- 30ns to Hard Shorts
- Fault Blanking
- Reverse Current Blocking

Applications

- PDAs
- Cell Phones
- Handheld GPS Devices
- Portable Enterprise / Industrial Devices
- Digital Cameras
- Peripheral Ports and Accessories
- Portable Medical Equipment
- Hot Swap Supplies

Description

The FPF2193, FPF2194, and FPF2195 form a series of load switches that provides full protection to systems and loads that may encounter large current conditions. These devices contain a $55 m\Omega$ current-limited P-channel MOSFET that can operate over an input voltage range of 1.8 to 5.5V. Internally, current is prevented from flowing when the MOSFET is off and the output voltage is higher than the input voltage. Switch control is by a logic input (ON) capable of interfacing directly with low-voltage control signals. Each part contains thermal shutdown protection that shuts off the switch to prevent damage to the part when a continuous over-current condition causes excessive heating.

When the switch current reaches the current limit, the parts operate in a constant-current mode to prohibit excessive currents from causing damage. For the FPF2193 and FPF2194, if the constant current condition still persists after 30ms, the parts shut off the switch and pull the fault signal pin (FLAGB) LOW. The FPF2193 has an auto-restart feature that turns the switch on again after 450ms if the ON pin is still active. The FPF2194 does not have this auto-restart feature, so the switch remains off until the ON pin is cycled. The FPF2195 does not turn off after a current limit fault, but remains in the constant-current mode indefinitely. The minimum current limit is 100mA.

These parts are available in a space-saving six ball advanced 1 x 1.5mm WLCSP package.

Ordering Information

Part Number	Current Limit [mA]	Current Limit Blanking Time [ms]	Auto-Restart Time [ms]	ON Pin Activity	Top Mark
FPF2193		15/30/60	225/450/900		S6
FPF2194	100-1500	15/30/60	NA	Active HIGH	S7
FPF2195		0	NA		S9

Application Diagram

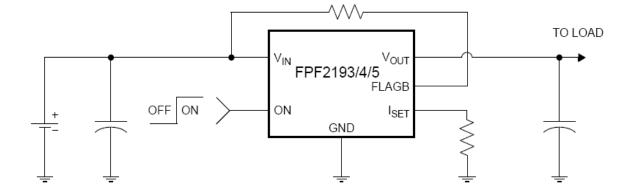


Figure 1. Typical Application

Block Diagram

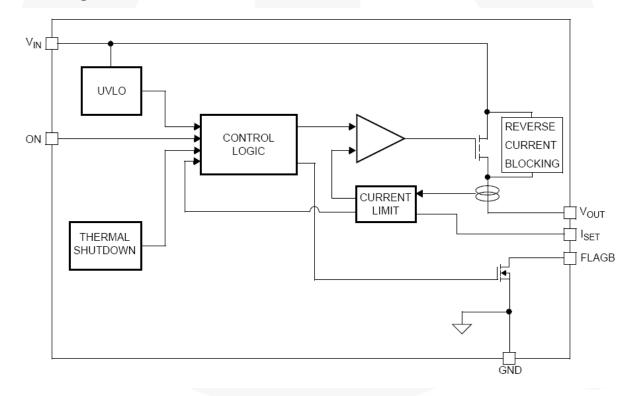


Figure 2. Functional Block Diagram

Pin Configuration

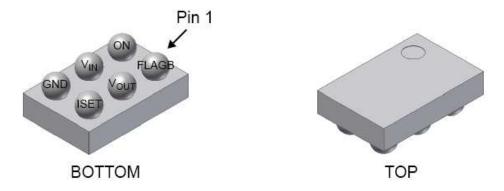


Figure 3. 1.0 x 1.5mm Chip-Scale Package

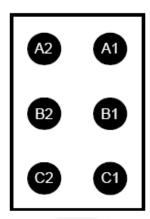


Figure 4. Pin Configuration (Bottom View)

Pin Definitions

Pin #	Name	Description
C1	I _{SET}	Current Limit Set Input. A resistor from I _{SET} to ground sets the current limit for the switch.
B2	V_{IN}	Supply Input. Input to the power switch and the supply voltage for the IC.
B1	V _{OUT}	Switch Output. Output of the power switch.
A1	FLAGB	Fault Output. Active LOW, open-drain output that indicates an over-current supply, undervoltage, or over-temperature state.
C2	GND	Ground.
A2	ON	ON control input, active HIGH.

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter			Max.	Unit
	V _{IN} , V _{OUT} , ON, FLAGB, ISET to GND			6.0	V
P _D	Power Dissipation at T _A = 25°C ⁽¹⁾			1.2	W
TJ	Operating Temperature Range		-40	+125	°C
T _{STG}	Storage Temperature		-65	+150	°C
Θ_{JA}	Thermal Resistance, Junction to Ambient			85	°C/W
ESD	Floateoatatia Diocharga Carability	Human Body Model, JESD22-A114	8000		V
	Electrostatic Discharge Capability	Machine Model, JESD22-A115	400		V

Notes:

1. Package power dissipation on one-square inch pad, two-ounce copper board.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

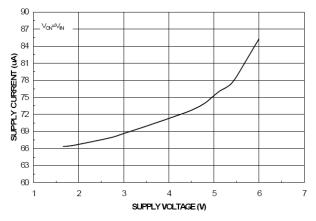
Symbol	Parameter	Min.	Max.	Unit
V _{IN}	Input Voltage	1.8	5.5	V
T _A	Ambient Operating Temperature	-40	+85	°C

Electrical Characteristics

 V_{IN} = 1.8 to 5.5V, T_A = -40 to +85°C unless otherwise noted. Typical values are at V_{IN} = 3.3V and T_A = 25°C.

Symbol	Parameter	Conditions		Min.	Тур.	Max.	Units
Basic Ope	ration						
V _{IN}	Operating Voltage			1.8		5.5	V
Iα			V _{IN} =1.8V		70		
	Quiescent Current	I_{OUT} =0mA, V_{ON} = V_{IN}	V _{IN} =3.3V		75		μA
			V _{IN} =5.5V		80		1
R _{on}	On Resistance	T _A =25°C, I _{OUT} =200mA			55	80	mΩ
NON	On Resistance	T _A =-40 to 85°C, I _{OUT} =200mA				135	
V_{IH}	On Input Logic High Voltage	V _{IN} =1.8V		0.8			V
V IH	ON	V _{IN} =5.5V		1.4			V
V_{IL}	On Input Logic Low Voltage	V _{IN} =1.8V				0.5	V
V IL	On input Logic Low Voltage	V _{IN} =%.5V				1.0	, v
	On Input Leakage	V _{ON} =V _{IN} or GND		-1	0	1	μA
	V _{IN} Shutdown Current	V_{ON} =0V, V_{IN} =5.5V, V_{OUT} =Short to GND		-2		2	μΑ
V	FLAGB Output Logic Low	V _{IN} =5V, I _{SINK} =10mA			0.05	0.20	V
V_{FLB_L}	Voltage	V _{IN} =1.8, I _{SINK} =10mA			0.12	0.30	V
V_{FLB_H}	FLAGB Output Logic High Leakage Current V _{IN} =5V, Switch ON					1	μA
Reverse B	lock						
I _{SDT}	V _{OUT} Shutdown Current	rrent $V_{ON}=0V, V_{OUT}=5.5V, V_{IN}=Short-to-GND$		-2		2	μA
V _{breakdown}	Reverse Breakdown Voltage	$V_{IN}=V_{ON}=0V$, $I_{OUT}=200\mu A$			9		V
Protection	S			•			
I _{LIM}	Current Limit	V_{IN} =3.3V, V_{OUT} =3.0V, R_{SET} =690 Ω		600	800	1000	mA
I _{LIM(MIN)}	Minimum Current Limit	V _{IN} =3.3V, V _{OUT} =3.0V			100		ma
		Shutdown Threshold			140		
TSD	Thermal Shutdown	Return from Shutdown			130		°C
		Hysteresis			10		
V _{UVLO}	Under-Voltage Lockout	tage Lockout V _{IN} Increasing		1.55	1.65	1.75	V
V _{UVLO_HYST}	Under-Voltage Lockout Hysteresis				50		mV
Dynamic							
td _{ON}	Delay On Time	R _L =500Ω, C _L =0.1μF	:		20		μs
t _R	V _{OUT} Rise Time	R _L =500Ω, C _L =0.1μF			20		μs
ton	Turn-On Time	R _L =500Ω, C _L =0.1μF			40		μs
td _{OFF}	Delay Off Time	R _L =500Ω, C _L =0.1μF			15		μs
t _F	V _{OUT} Fall Time	R _L =500Ω, C _L =0.1μF			110		μs
toff	Turn-Off Time	R _L =500Ω, C _L =0.1μF			125		μs
t _{BLANK}	Over-Current Blanking Time	FPF2193, FPF2194		15	30	60	ms
trstrt		FPF2193		225	450	900	
	Auto-Restart	FPF2194, FPF2195			NA		ms
tsc	Short-Circuit Response Time	V _{IN} =V _{OUT} =3.3V, Mod Current Condition			5		μs
isc	SS.C S.I. SAIL I COPOLIGO TIMO	V _{IN} =V _{OUT} =3.3V, Hard Short			30		ns

Typical Performance Characteristics



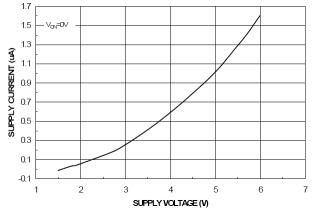


Figure 5. Quiescent Current vs. Input Voltage

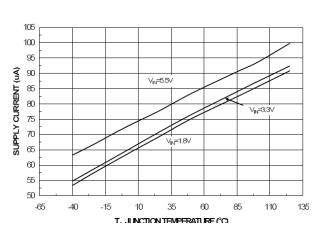


Figure 6. Quiescent Current vs. Input Voltage

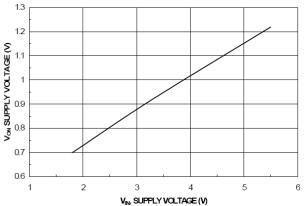


Figure 7. Quiescent Current vs. Temperature

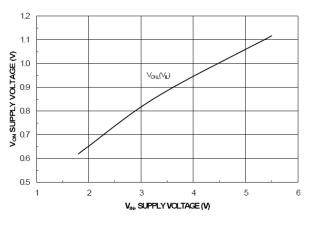


Figure 8. V_{ON} High Voltage vs. Input Voltage

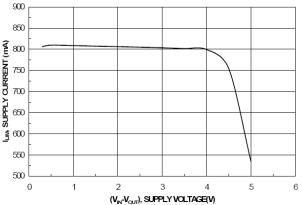
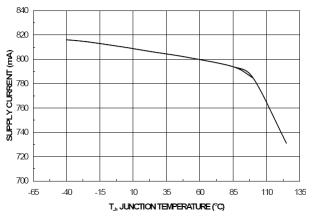


Figure 9. V_{ON} Low Voltage vs. Input Voltage

Figure 10. Current Limit vs. Output Voltage

Typical Performance Characteristics (Continued)



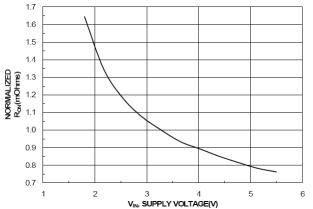
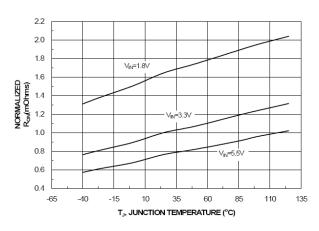


Figure 11. Current Limit vs. Temperature





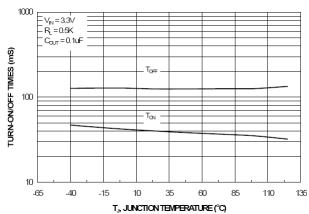
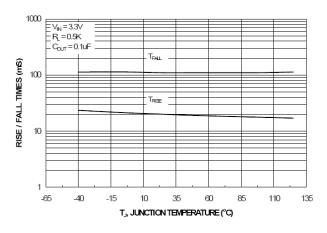


Figure 13. R_{ON} vs. Temperature

Figure 14. t_{ON} / t_{OFF} vs. Temperature



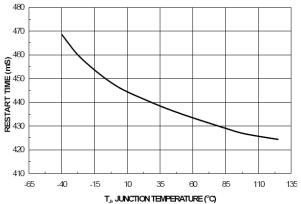
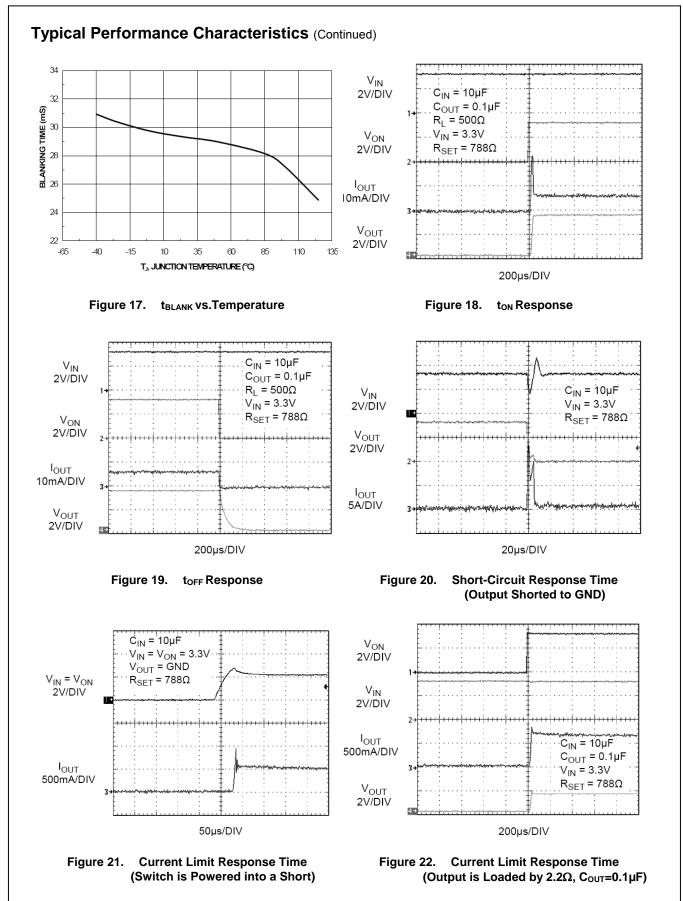


Figure 15. t_{RISE} / t_{FALL} vs. Temperature

Figure 16. t_{RSTRT} vs. Temperature



Typical Performance Characteristics (Continued)

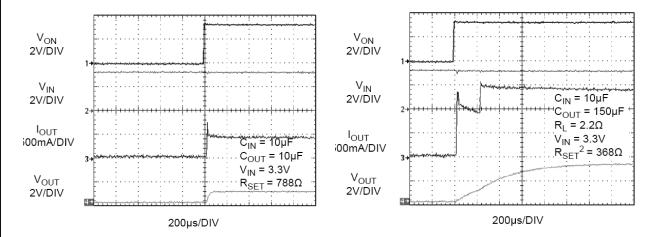


Figure 23. Current Limit Response Time (Output is Loaded by 2.2Ω, C_{OUT}=10μF)

Figure 24. Short-Circuit Detection Function⁽²⁾

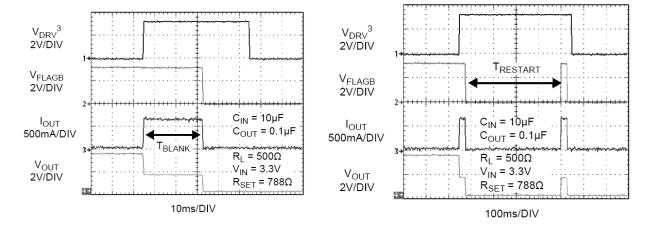


Figure 25. t_{BLANK} vs. Response⁽³⁾

Figure 26. t_{RESTART} vs. Response⁽³⁾

Notes:

- 2. When the output voltage is below V_{SCTH}=1.1V, the current limit value is set at 62.5% of the current limit value.
- 3. V_{DRV} signal forces the device to go into over-current condition by loading.

Functional Description

The FPF2193, FPF2194, and FPF2195 are currentlimited switches that protect systems and loads that can be damaged or disrupted by the application of high currents. The core of each device is a $55m\Omega$ P-channel MOSFET and a controller capable of functioning over the wide input operating range of 1.8- 5.5V. The controller protects against system malfunctions through current limiting, under-voltage lockout, and thermal shutdown. The current limit is adjustable from 100mA to 1.5A through the selection of an external resistor.

On/Off Control

The ON pin controls the state of the switch. When ON is HIGH, the switch is in ON state. Activating ON continuously holds the switch in the ON state so long as there is no fault. For all versions, an under-voltage on VIN or a junction temperature in excess of 140°C overrides the ON control to turn off the switch. In addition. excessive currents cause the switch to turn off in the FPF2193 and FPF2194. The FPF2193 has an autorestart feature that automatically turns the switch on again after 450ms. For the FPF2194, the ON pin must be toggled to turn the switch on again. The FPF2195 does not turn off in response to an over-current condition, but remains operating in constant-current mode aslong as ON is active and the thermal shutdown or under-voltage lockout have not activated.

Fault Reporting

Upon the detection of an over-current, input undervoltage, or over-temperature condition, FLAGB signals the fault mode by activating LOW. For the FPF2193 and FPF2194, the FLAGB goes LOW at the end of the blanking time, while FLAGB goes LOW immediately for the FPF2195. FLAGB remains LOW through the autorestart time for the FPF2195. For the FPF2194, FLAGB is latched LOW and ON must be toggled to release it. With the FPF2195, FLAGB is LOW during the faults and immediately returns HIGH at the end of the fault condition. FLAGB is an open-drain MOSFET that requires a pull-up resistor between V_{IN} and FLAGB. During shutdown, the pull-down on FLAGB is disabled to reduce current draw from the supply.

Current Limiting

The current limit ensures that the current through the switch doesn't exceed a maximum value, while not limiting at less than a minimum value. The current at which the parts limit is adjustable through the selection of an external resistor connected to I_{SET}. Information for selecting the resistor is found in the Application Information section. The FPF2193 and FPF2194 have a blanking time of 30ms, nominally, during which the switch acts as a constant current source. At the end of the blanking time, the switch is turned off. The FPF2195 has no current limit blanking period, so it remains in a constant current state until the ON pin is deactivated or the thermal shutdown turns off the switch.

For preventing the switch from large power dissipation during heavy load, a short-circuit detection feature is introduced. Short-circuit condition is detected by, observing the output voltage. The switch is put into shortcircuit current-limiting mode if the switch is loaded with a

heavy load. When the output voltage drops below V_{SCTH}, the short-circuit detection threshold voltage, the current limit value is re-conditioned and the short-circuit currentlimit value is decreased to 62.5% of the current limit value. This keeps the power dissipation of the part below a certain limit even at dead-short conditions at 5.5V input voltage. The V_{SCTH} value is set to be 1V. At around 1.1V of output voltage, the switch is removed from short-circuit current-limiting mode and the current limit is set to the current limit value.

Under-Voltage Lockout (UVLO)

The under-voltage lockout turns the switch off if the input voltage drops below the under-voltage lockout threshold. With the ON pin active, the input voltage rising above the under-voltage lockout threshold causes a controlled turnon of the switch, which limits current over shoot.

Thermal Shutdown

The thermal shutdown protects the die from internally or externally generated excessive temperatures. During an over-temperature condition, FLAGB is activated and the switch is turned off. The switch automatically turns on again if temperature of the die drops below the threshold temperature.

Reverse-Current Blocking

The entire FPF2193/94/95 family has a reverse current blocking feature that protects the input source against current flow from output to input. For a standard USB power design, this is an important feature to protect the USB host from being damaged due to reverse current flow on V_{BUS}.

When the load switch is OFF, no current flows from the output to the input. If the switch is turned on and the output voltage is greater than input voltage, this feature is activated and turns off the switch. This prevents any current flow from output to input. The reverse-current blocking feature is deactivated if the V_{OUT} - V_{IN} is smaller than a typically 50mV threshold. During this time, some current (50mV/R_{ON}) flows from the output to input until input voltage becomes greater than output voltage. FLAGB operation is independent of the reverse-current blocking and does not report a fault condition if this feature is activated.

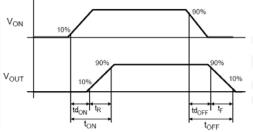


Figure 27. **Timing Diagram**

where:

tdon = Delay On Time $t_R = V_{OUT}$ Rise Time t_{ON} = Turn-On Time td_{OFF} = Delay Off Time $t_F = V_{OUT}$ Fall Time toff = Turn-Off Time

Application Information

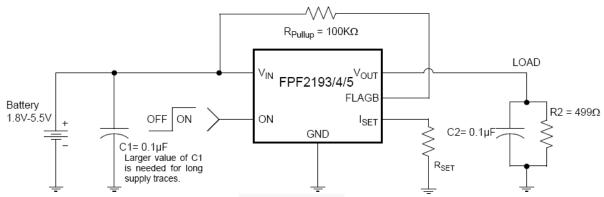


Figure 28. Typical Application

Setting Current Limit

The FPF2193, FPF2194, and FPF2195 current limit is set with an external resistor connected between I_{SET} and GND. This resistor is selected using the following equation:

$$R_{SET} = \frac{551.6}{I_{LIM}} \tag{1}$$

 R_{SET} is in Ω and I_{SET} is in Amps.

Table 1 can also be used to select R_{SET} . A typical application would be the 500mA current required by a single USB port. Using Table 1, an appropriate selection for the R_{SET} resistor would be 788 Ω . This ensures that the port load could draw 525mA, but not more than 875mA. Likewise for a dual-port system; an R_{SET} of 368 Ω always delivers at least 1125mA and never more than 1875mA.

Table 1. Current Limit Various R_{SET} Values

R _{SET} (Ω)	Min. Current Limit(mA)	Typ. Current Limit(mA)	Max. Current Limit(mA)	
368	1125	1500	1875	
441	928	1250	1562	
552	750	1000	1250	
613	675	900	1125	
690	600	800	1000	
788	525	700	875	
919	450	600	750	
1103	375	500	625	
1226	338	450	563	
1379	300	400	500	
1576	263	350	438	
1839	225	300	375	
2206	188	250	313	
2758	150	200	250	
3677	113	150	188	
5516	75	100	125	

Input Capacitor

To limit the voltage drop on the input supply caused by transient inrush currents when the switch is turned on into a discharged load capacitor or a short-circuit, a capacitor needs to be placed between V_{IN} and GND. A 0.1µF ceramic capacitor, C_{IN} , placed close to the pins is usually sufficient. Higher values of C_{IN} can be used to further reduce the voltage drop.

Output Capacitor

A 0.1 μ F capacitor, C_{OUT} , should be placed between V_{OUT} and GND. This capacitor prevents parasitic board inductances from forcing V_{OUT} below GND when the switch turns off. For the FPF2193 and FPF2194, the total output capacitance needs to be kept below a maximum value, $C_{OUT}(max)$, to prevent the part from registering an over-current condition and turning off the switch. The maximum output capacitance can be determined from the following formula:

$$C_{OUT}(max) = \frac{I_{LIM}(max) \times t_{BLANK}(min)}{V_{IN}}$$
 (2)

Power Dissipation

During normal operation as a switch, the power dissipated depends upon the level at which the current limit is set. The maximum allowed setting for the current limit is 1.5A and results in a power dissipation of:

$$P = (I_{LIM})^2 \times R_{ON} = (1.5)^2 \times 0.055 = 123.75 \text{mW}$$
 (3)

If the part goes into current limit, the maximum power dissipation occurs when the output is shorted to ground. For the FPF2193, the power dissipation scales by the auto-restart time, t_{RSTRT} , and the over-current blanking time, t_{BLANK} , so that the maximum power dissipated is:

$$P(max) = \frac{t_{BLANK}}{t_{BLANK} + t_{RSTRT}} \times V_{IN}(max) \times I_{LIM}(max)$$

$$= \frac{30}{30 + 450} \times 5.5 \times 1.5 = 515.6 \text{mW}$$
(4)

This is more power than the package can dissipate, but the thermal shutdown of the part activates to protect the part from damage due to excessive heating. When using the FPF2194, attention must be given to the manual resetting of the part. The junction temperature is only able to increase to the thermal shutdown threshold. Once this temperature has been reached, toggling ON does not turn the switch on until the junction temperature drops. For the FPF2195, a short on the output causes the part to operate in a constant-current state, dissipating a worst-case power of:

$$P(max) = V_{IN}(max) \times I_{LIM}(max)$$

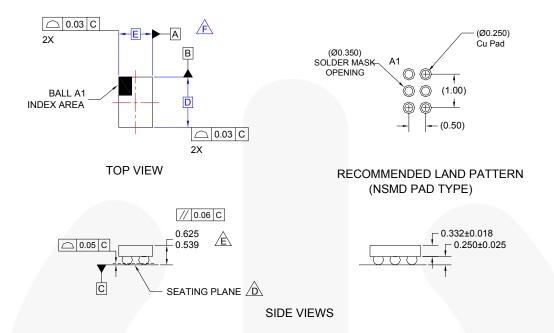
= 5.5 \times 1.5 = 8.25 W (5)

This large amount of power activates the thermal shutdown and the part cycles in and out of thermal shutdown as long as the ON pin is active and the short is present.

Board Layout

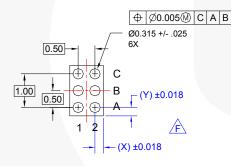
For best performance, all traces should be as short as possible. To be most effective, the input and output capacitors should be placed close to the device to minimize the effects that parasitic trace inductances may have on normal and short-circuit operation. Using wide traces for V_{IN} , V_{OUT} , and GND help to minimize parasitic electrical effects along with minimizing the case-to-ambient thermal impedance.

Physical Dimensions



NOTES:

- A. NO JEDEC REGISTRATION APPLIES.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCE PER ASMEY14.5M. 1994.
- DATUM C IS DEFINED BY THE SPHERICAL CROWNS OF THE BALLS.
- EPACKAGE NOMINAL HEIGHT IS 582 MICRONS ±43 MICRONS (539-625 MICRONS).
- F. FOR DIMENSIONS D, E, X, AND Y SEE PRODUCT DATASHEET.
- G. DRAWING FILNAME: MKT-UC006AFrev2.



BOTTOM VIEW

Figure 29. 6-Ball, Wafer-Level Chip-Scale Package (WLCSP)

Product	D	E	X	Υ
FPF2193	1.500+/-0.030	1.000+/-0.030	0.240	0.240
FPF2194	1.500+/-0.030	1.000+/-0.030	0.240	0.240
FPF2195	1.500+/-0.030	1.000+/-0.030	0.240	0.240

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Saving our world, 1mW/W/kW at a time™ SignalWise™ SmartMax™

SmartMax™ SMART START™ SPM®

STEALTH™
STEALTH™
SuperSOT™3
SuperSOT™6
SuperSOT™8
SuperSOT™8
SupreMOS®
SyncFET™
SyncFLock™

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TinyBuck™
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Definition of Terms

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Datasheet Identification	Product Status	Definition			
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.			
Preliminary	First Production	Data sheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.			
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